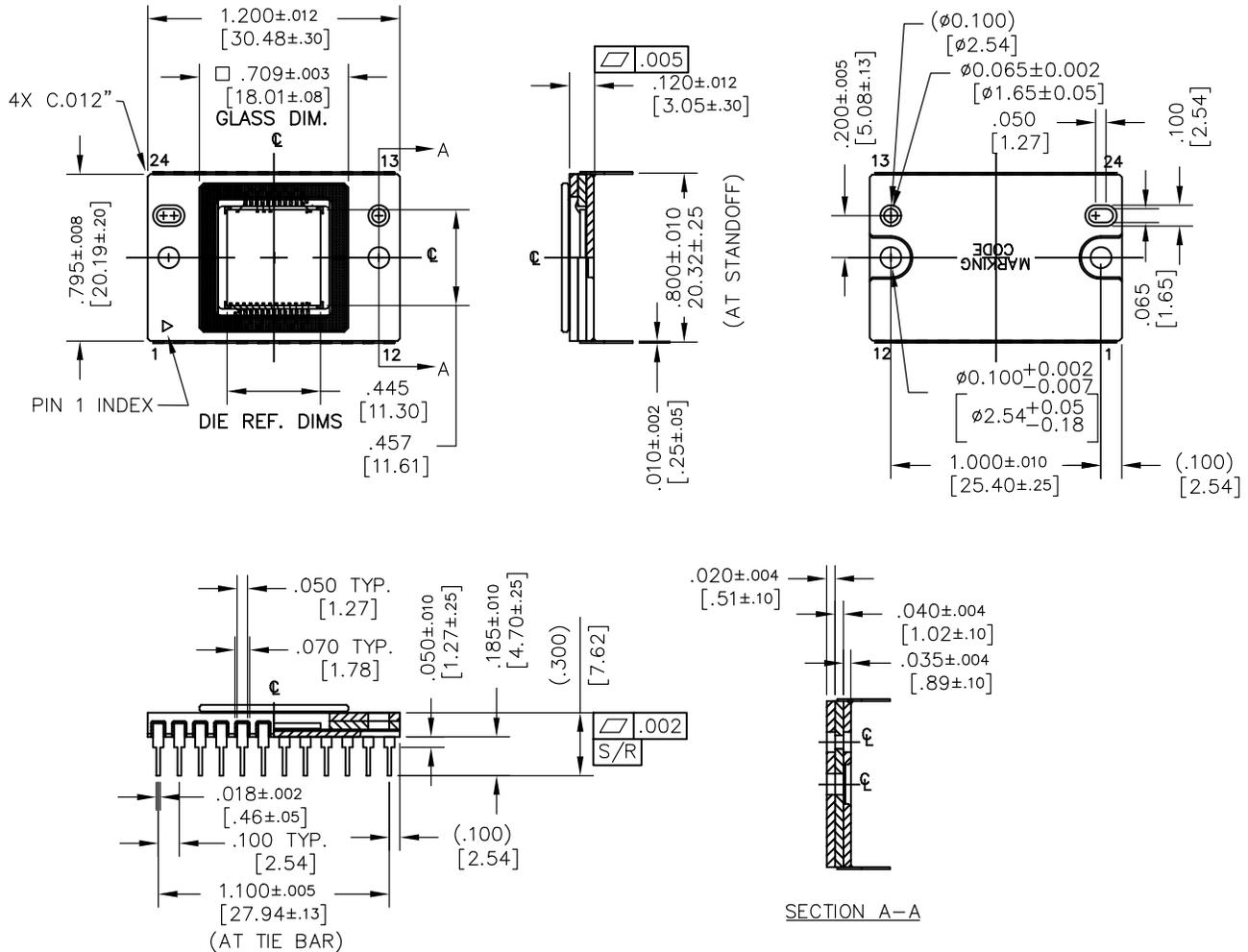


CERAMIC DIP 24
CASE 125AV
ISSUE O

DATE 30 JUN 2014



- NOTES:
1. COVER GLASS IS MANUALLY PLACED AND VISUALLY ALIGNED OVER DIE - LOCATION ACCURACY IS NOT GUARANTEED.

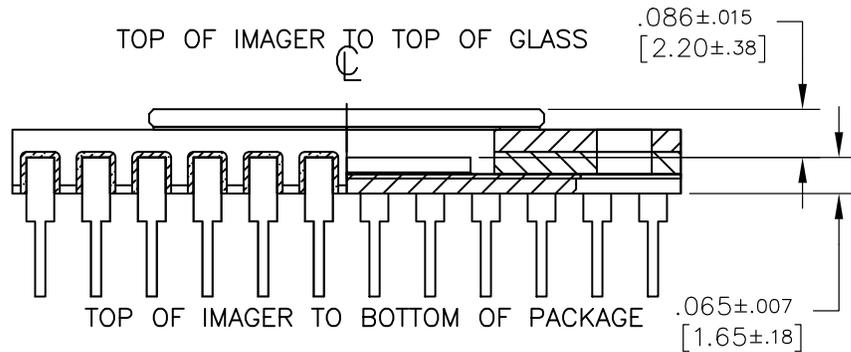
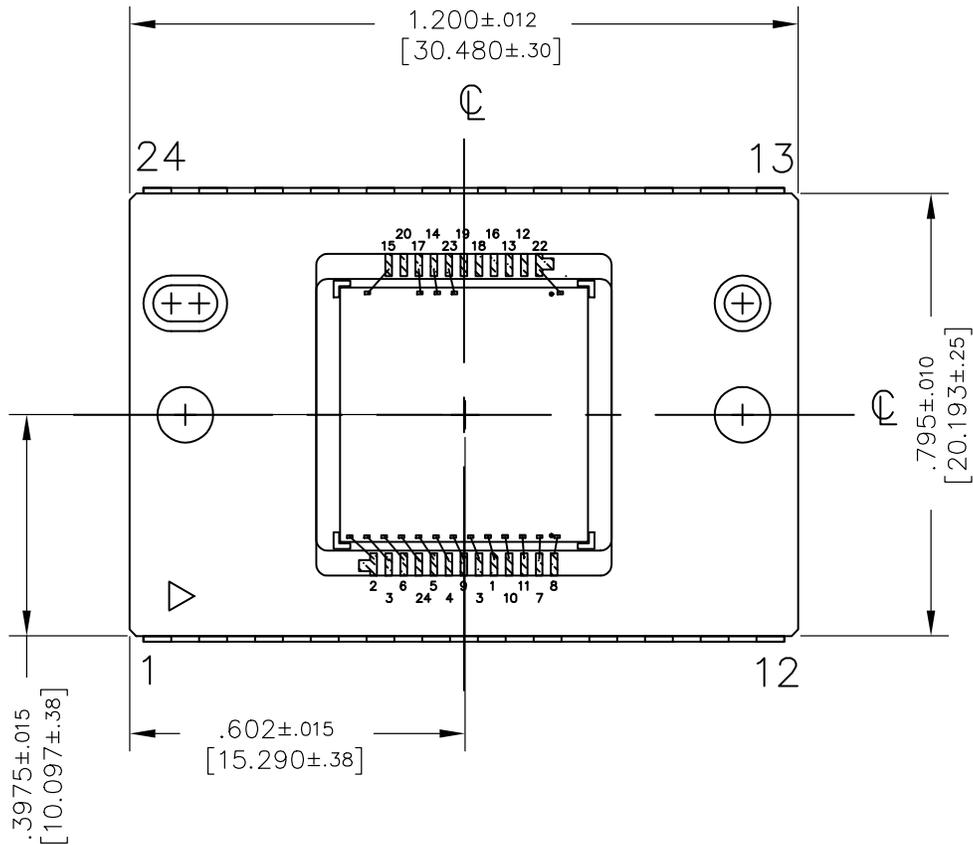
Dimensions in: Inches [mm]

DOCUMENT NUMBER:	98AON86712F	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	CERAMIC DIP 24	PAGE 1 OF 2

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

CERAMIC DIP 24
CASE 125AV
ISSUE O

DATE 30 JUN 2014



NOTES:

1. CENTER OF IMAGE IS OFFSET FROM CENTER OF PACKAGE BY (.05, .00)mm NOMINAL.
2. DIE IS ALIGNED WITHIN ± 2 DEGREE OF ANY PACKAGE CAVITY EDGE.

Dimensions in: Inches [mm]

DOCUMENT NUMBER:	98AON86712F	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	CERAMIC DIP 24	PAGE 2 OF 2

onsemi and **ONSEMI** are trademarks of Semiconductor Components Industries, LLC dba **onsemi** or its subsidiaries in the United States and/or other countries. **onsemi** reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights nor the rights of others.